PDC1045C SERIES

1. PART NO. EXPRESSION :

P D C 1 0 4 5 C - 2 R 2 M F				
(a)	(b)	(c)	(d)	(e)(f)

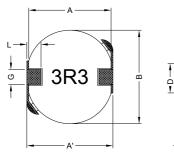
(a)	Series	code	

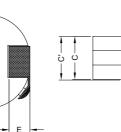
- (b) Dimension code(c) Type code
- (d) Inductance code : 2R2 = 2.2uH

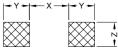
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- (e) Tolerance code : $M = \pm 20\%$
- (f) F : Lead Free

2. CONFIGURATION & DIMENSIONS :







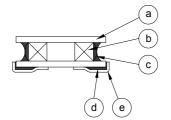
PCB Pattern

					Unit : mm
А	В	С	D	Е	F
10.5 Max.	10±0.5	4.5 Max.	3.0±0.2	1.2±0.2	7.7±0.5
G	Н	L	х	Y	Z
1.4±0.2	155±0.2	0.7±0.2	7.40 Ref.	1.70 Ref.	3.60 Ref.

Е

3. SCHEMATIC :

4. MATERIALS :



- (a) Core : Ferrite Core
- (b) Wire : Enamelled Copper Wire
- (c) Adhesive : Epoxy
- (d) Adhesive : Epoxy
- (e) Clip : Tin Clip



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5. GENERAL SPECIFICATION :

a) Test Frequency : 100KHz/0.25Vdc

b) Ambient Temp. : 20°C

c) Irms(A) : Will cause coil temperature to rise $\Delta T \leq 40^{\circ}C$

d) $\mbox{Isat}(A)$: Will cause L0 to drop approximately 30%

e) Operating temp. : -20°C to +105°C (include self-temp. rise)

6. ELECTRICAL CHARACTERISTICS :

Part No.	Inductance (µH)	DCR (mΩ) Max.	Irms (A) Max.	Isat (A) Max.
PDC1045C-2R2MF	2.2 ±20%	7.2	8	9.25
PDC1045C-3R3MF	3.3 ±20%	13.0	5.5	6.0
PDC1045C-4R7MF	4.7 ±20%	22.0	4.8	5.0
PDC1045C-7R0MF	7.0 ±20%	27.0	5.5	5.5
PDC1045C-100MF	10 ±20%	27.0	4.0	4.5

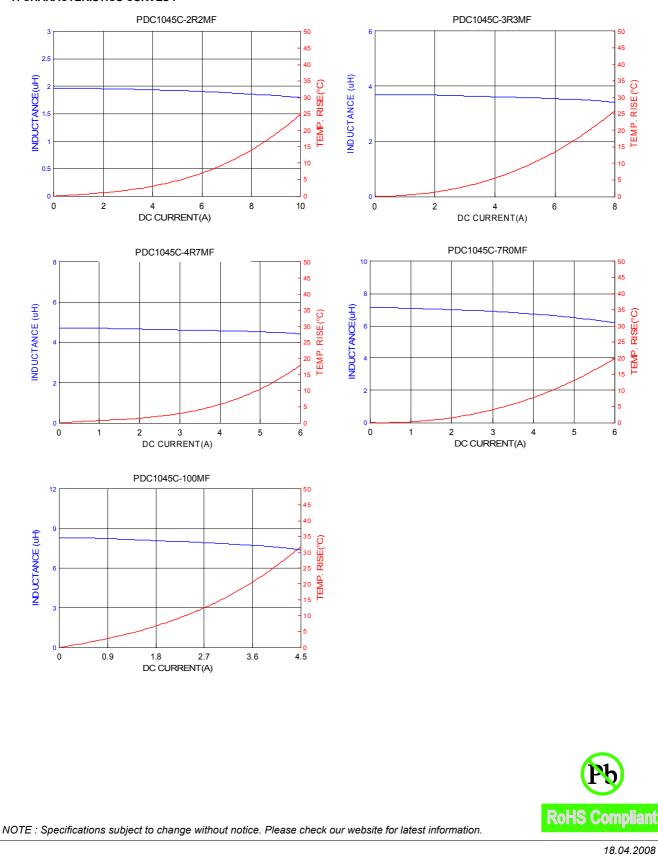


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7. CHARACTERISTICS CURVES :

8. ELECTRICAL CHARACTERISTICS :

ITEM	JUDGEMENT STANDARD	TEST CONDITION	
Mechanical Performance T	est		
Solderability Test	More than 90% of the terminal electrode should be covered with solder.	Preheat : 150°C, 60sec. Solder : lead free (recommend) Solder Temperature : 245±5°C Flux for lead free : rosin Dip Time : 5±1sec. 150°C	
Solder Heat Resistance	 Appearance : No damage Inductance change : Within ±10% of initial value 	Preheat : 150°C Preheat time : 1 min Solder Temperature : 260 \pm 5°C Dip Time : 10 \pm 1sec. Preheating Dipping Natural 260°C 150°C $60 + 10\pm$ 1 seconds Measure at room temperature after placing for 24 hrs.	
Reliability Test			
Humidity Resistance	 Appearance : No damage All electrical and mechanical parameters within tolerance 	Temperature : 40±2°C Humidity : 90% to 95% Applied Current : Rated Current Time : 500±12 hours Component should be stabilized at normal condition for 24±2 hours before test.	
High Temperature Life Test		Temperature : 85±3°C Time : 500+24/-0 hrs Component should be stabilized at normal condition for 24±2 hours before test.	
Low Temperature Life Test	 Appearance : No damage All electrical and mechanical parameters within tolerance 	Temperature : -40±3°C Time : 500+24/-0 hrs Component should be stabilized at normal condition for 24±2 hours before test.	
Temperature Cycle (Thermal Shock)		$\begin{tabular}{ c c c c c c c c c c c c c c c c } \hline Conditions of 1 cycle. \\ \hline \hline Step & Temperature (°C) & Times (min.) \\ \hline 1 & -40\pm3 & 30 \\ \hline 2 & 25\pm2 & Within 3 \\ \hline 3 & +85\pm3 & 30 \\ \hline 4 & 25\pm2 & Within 3 \\ \hline Total : 10 cycles \\ \hline Component should be stabilized at normal condition for 24\pm2 hours before test. \\ \hline \end{tabular}$	
Drop	Drop 10 times on a concrete floor from a height of 1m.	No mechanical damage All electrical and mechanical parameters within tolerance	
Electrical Characteristics T	est		
Heat Rated Current (Irms)	Idc(Irms) @ $\Delta \leq 45^{\circ}$ C a. Δ T is the component surface temperature rise scope in room temperature, the test component surface temperature increase not more than 45°C b. Body should not be damaged	 Ambient temp : 25°C with inhibitive ventilation condition Applied Current : DC Current, the current shall be step by step increase to the load component. 	
Saturation Current (Isat)	Isat @ L ≥ 70% L0 L : test inductance with DC current L0: the initial inductance without DC current	 Ambient temp : 25°C Applied Current : DC Current, the current shall be step by step increase to the load component. 	

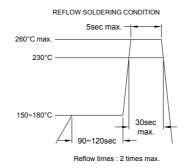
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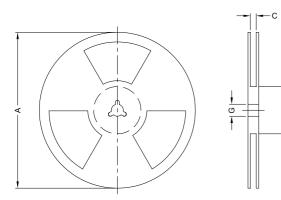
PDC1045C SERIES

PDC1045C SERIES



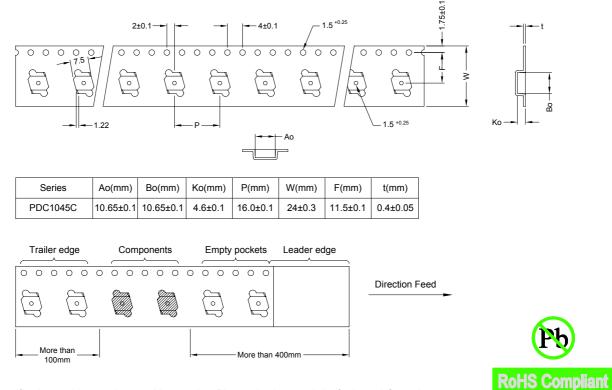
9. PACKAGING INFORMATION :

9-1. Reel Dimension



Туре	A(mm)	C(mm)	G(mm)	N(mm)
13" x 24mm	330	24.5±0.5	13.5±0.5	100±1.0

9-2 Tape Dimension / 12mm



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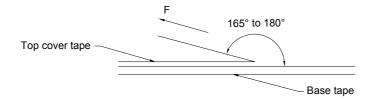
PG. 5

PDC1045C SERIES

9-3. Packaging Quantity

Size	PDC1045C
Chip / Reel	1000
Inner Box	2000
Carton	8000

9-4. Tearing Off Force



The force for tearing off cover tape is 10 to 125 grams in the arrow direction under the following conditions.

Room Temp.	Room Humidity	Room atm	Tearing Speed
(°C)	(%)	(hPa)	(mm/min)
5~35	45~85	860~1060	

Application Notice

1. Storage Conditions :

- To maintain the solderabililty of terminal electrodes :
 - a) Temperature and humidity conditions : Less than 40°C and 70% RH.
 - b) Recommended products should be used within 6 months from the time of delivery.
 - c) The packaging material should be kept where no chlorine or sulfur exists in the air.

2. Transportation :

- a) Products should be handled with care to avoid damage or contamination from perspiration and skin oils.
- b) The use of tweezers or vacuum pick up is strongly recommended for individual components.
- c) Bulk handling should ensure that abrasion and mechanical shock are minimized.



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